MRF317

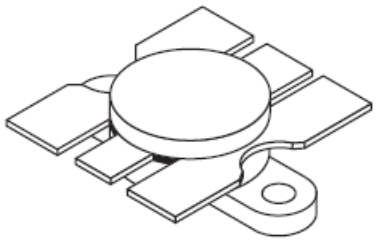
The RF Line NPN Silicon Power Transistor
100W, 30-200MHz, 28V

Rev. V1

Designed primarily for wideband large–signal output amplifier stages in 30–200 MHz frequency range.

- Guaranteed performance at 150 MHz, 28 Vdc
  Output power = 100 W
  Minimum gain = 9.0 dB
- Built–in matching network for broadband operation
- 100% tested for load mismatch at all phase angles with 30:1 VSWR
- Gold metallization system for high reliability
- High output saturation power — ideally suited for 30 W carrier/120 W
- Peak AM amplifier service
- Guaranteed performance in broadband test fixture

Product Image



CASE 316–01, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	35	Vdc
Collector–Base Voltage	V_{CBO}	65	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector Current — Continuous — Peak (10 seconds)	I_C	12 18	Adc
Total Device Dissipation @ T_C = 25°C (1) Derate above 25°C	P_D	270 1.54	Watts W/°C
Storage Temperature Range	T_{stg}	–65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.65	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit

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OFF CHARACTERISTICS

Collector–Emitter Breakdown Voltage (I_C = 100 mAdc, I_B = 0)	$V_{(BR)CEO}$	35	—	—	Vdc
Collector–Emitter Breakdown Voltage (I_C = 100 mAdc, V_{BE} = 0)	$V_{(BR)CES}$	65	—	—	Vdc
Collector–Base Breakdown Voltage (I_C = 100 mAdc, I_E = 0)	$V_{(BR)CBO}$	65	—	—	Vdc
Emitter–Base Breakdown Voltage (I_E = 10 mAdc, I_C = 0)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector Cutoff Current (V_{CB} = 30 Vdc, I_E = 0)	I_{CBO}	—	—	5.0	mAdc

ON CHARACTERISTICS

DC Current Gain (I_C = 5.0 Adc, V_{CE} = 5.0 Vdc)	h_{FE}	10	25	80	—

NOTE: (continued)

1. This device is designed for RF operation. The total device dissipation rating applies only when the device is operated as an RF amplifier.

ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
DYNAMIC CHARACTERISTICS					
Output Capacitance (V_{CB} = 28 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	—	150	175	pF
FUNCTIONAL TESTS (Figure 2)					
Common–Emitter Amplifier Power Gain (V_{CC} = 28 Vdc, P_{out} = 100 W, f = 150 MHz, I_C (Max) = 6.5 Adc)	G_{PE}	9.0	10	—	dB
Collector Efficiency (V_{CC} = 28 Vdc, P_{out} = 100 W, f = 150 MHz, I_C (Max) = 6.5 Adc)	η	55	60	—	%
Load Mismatch (V_{CC} = 28 Vdc, P_{out} = 100 W CW, f = 150 MHz, VSWR = 30:1 all phase angles)	ψ	No Degradation in Output Power			

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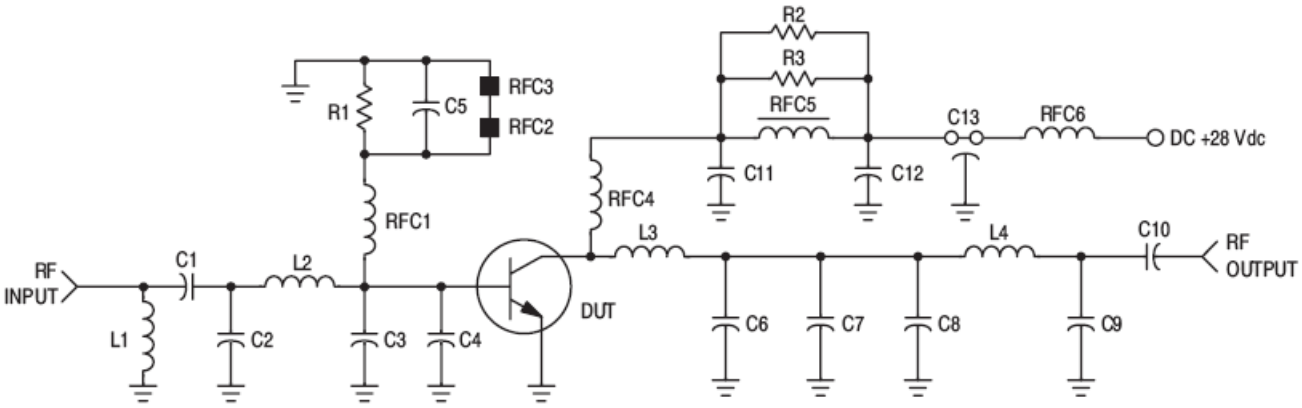

C1, C9 — 39 pF, 100 mil ATC
C2 — 120 pF, 100 mil ATC
C3, C4 — 360 pF, 100 mil ATC
C5 — 1000 pF Dipped Mica
C6, C7 — 100 pF, 100 mil ATC*
C8 — 18 pF, 100 mil ATC*
C10 — 43 pF, 100 mil ATC

C11 — 60 pF, Underwood
C12 — 0.1 µF Erie Redcap
C13 — 1000 pF, Underwood J102
L1 — 50 nH
L2 — 6.0 nH
L3 — 8.0 nH
L4 — 32 nH

RFC1 — 0.15 µH Molded Coil
RFC2, RFC3 — Ferroxcube Bead 56–590–65/3B
RFC4 — 1 Turn, #18 Wire, 2.0″ L
RFC5 — Ferroxcube VK200 19/4B
RFC6 — 7 Turns, #18 Wire, 0.3″ ID
R1 — 10 Ω 1/2 W
R2, R3 — 10 Ω 1.0 W
*Combination of C6, C7, C8 equals 220 pF.

Figure 1. 110–160 MHz Broadband Amplifier — Test Fixture Schematic

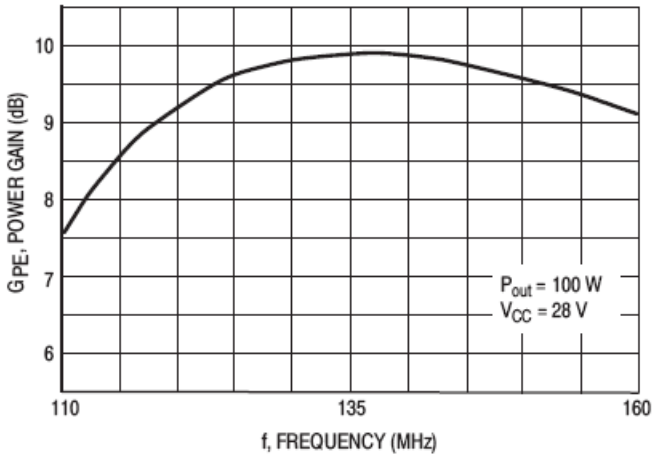

Figure 2. Power Gain versus Frequency Broadband Test Fixture

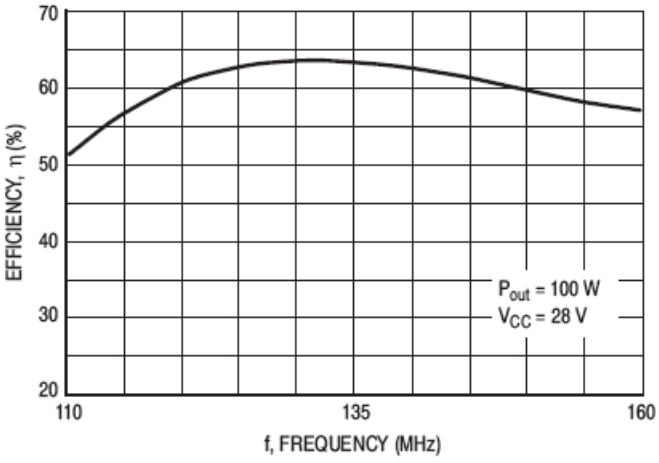

Figure 3. Efficiency versus Frequency Broadband Test Fixture

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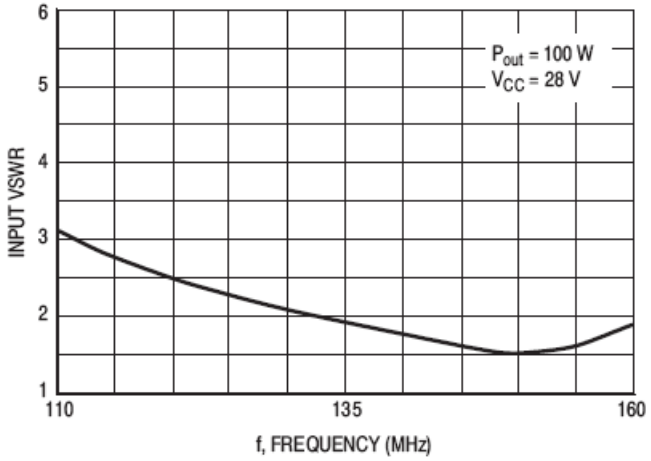


Figure 4. Input VSWR versus Frequency
Broadband Test Fixture

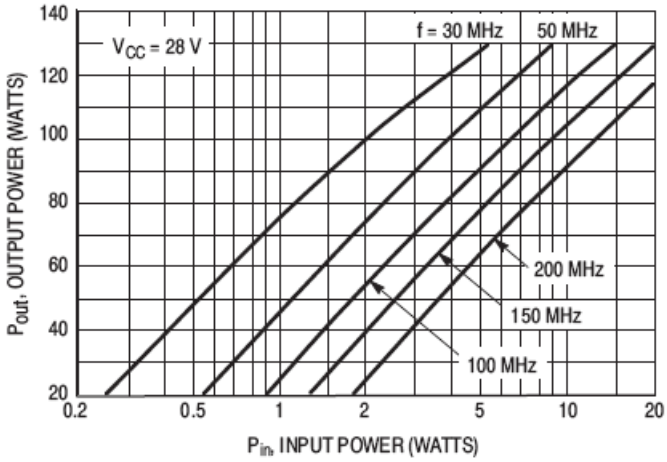


Figure 5. Output Power versus Input Power

TYPICAL PERFORMANCE CURVES

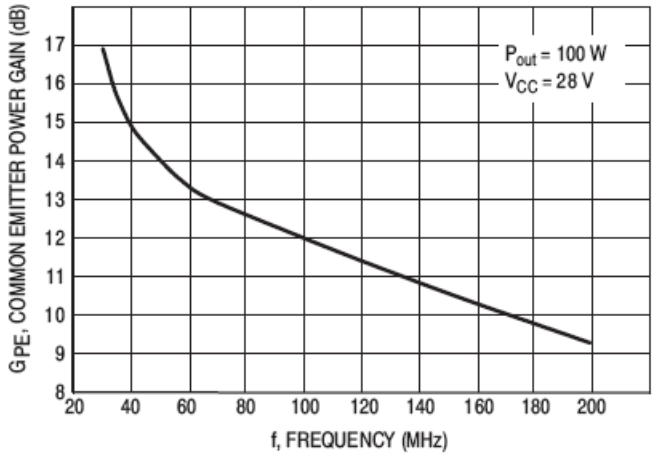


Figure 6. Power Gain versus Frequency

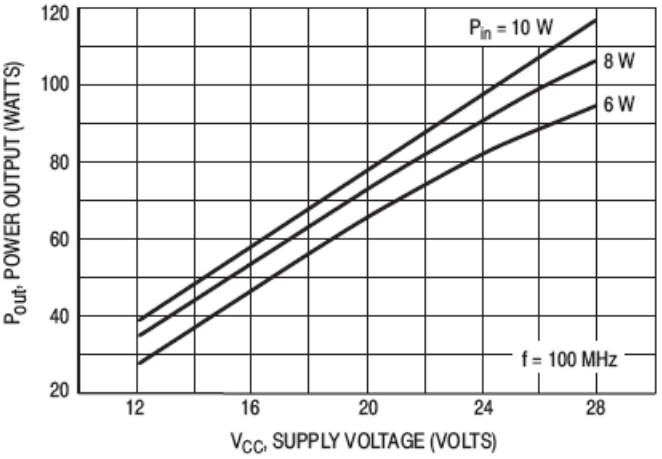


Figure 7. Power Output versus Supply Voltage

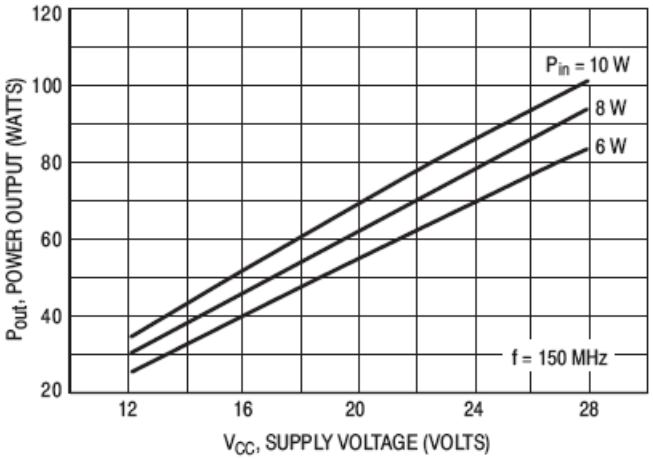


Figure 8. Power Output versus Supply Voltage

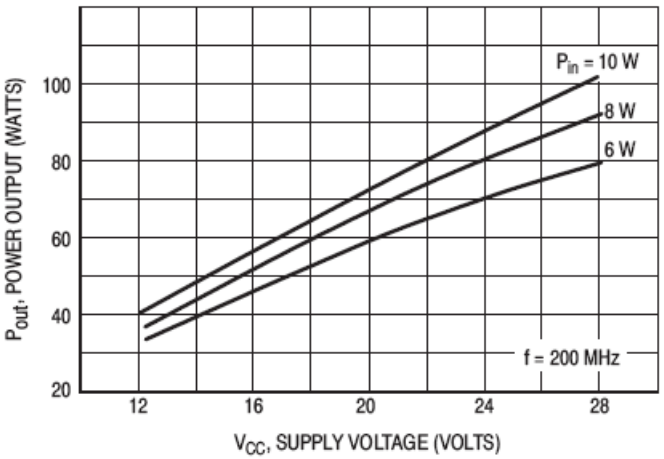
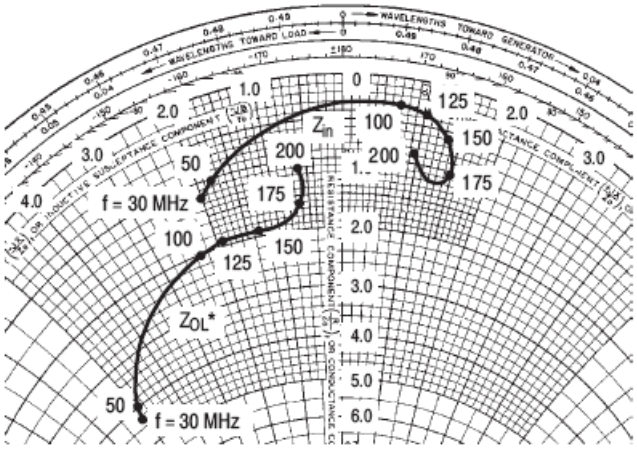


Figure 9. Power Output versus Supply Voltage



V_{CC} = 28 V, P_{out} = 100 W

f MHz	Z_{in} OHMS	Z_{OL}* OHMS
30	1.2 – j2.0	4.3 – j5.0
50	1.0 – j1.8	4.0 – j4.9
100	0.3 + j0.7	2.0 – j2.3
125	0.3 + j1.0	1.9 – j1.9
150	0.6 + j1.3	1.9 – j1.3
175	1.0 + j1.5	1.6 – j0.6
200	0.9 + j1.0	1.1 – j0.6

Z_{OL}* = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

Figure 10. Series Equivalent Input–Output Impedance

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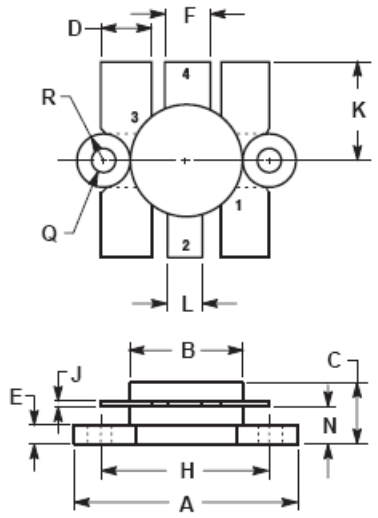
PACKAGE DIMENSIONS



NOTES:
1. FLANGE IS ISOLATED IN ALL STYLES.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	24.38	25.14	0.960	0.990
B	12.45	12.95	0.490	0.510
C	5.97	7.62	0.235	0.300
D	5.33	5.58	0.210	0.220
E	2.16	3.04	0.085	0.120
F	5.08	5.33	0.200	0.210
H	18.29	18.54	0.720	0.730
J	0.10	0.15	0.004	0.006
K	10.29	11.17	0.405	0.440
L	3.81	4.06	0.150	0.160
N	3.81	4.31	0.150	0.170
Q	2.92	3.30	0.115	0.130
R	3.05	3.30	0.120	0.130
U	11.94	12.57	0.470	0.495

STYLE 1:
PIN 1. EMITTER
2. COLLECTOR
3. EMITTER
4. BASE

CASE 316–01
ISSUE D